

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L3	2	(29/610.1).ccls. and (thick adj resistor) and substrate and (passivation or mask or photomask or (dry adj film) or dielectric)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:19
L4	4	(29/825,829,846).ccls. and (resistor) and (circuit) and substrate and ((passivation or mask or photomask or (dry adj film) or protection) adj layer) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:22
L5	1	(29/857,868,874).ccls. and (resistor) and (circuit) and substrate and ((passivation or mask or photomask or (dry adj film) or protection) adj layer) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:23
L6	3	(361/321.4).ccls. and (resistor) and (circuit) and substrate and (passivation or mask or photomask or (dry adj film)) and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:23
L7	5	(216/16,40).ccls. and (resistor) and (circuit) and substrate and (passivation or mask or photomask or (dry adj film)) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:24
L8	15	(174/255,260).ccls. and (resistor) and (circuit) and substrate and ((passivation or mask or photomask or (dry adj film) or protection) adj layer) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:24
L9	1	(438/745).ccls. and (resistor) and (circuit) and substrate and (passivation or mask or photomask or (dry adj film)) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:25
L10	2	(427/101).ccls. and (resistor) and (circuit) and substrate and ((passivation or mask or photomask or (dry adj film) or protection) adj layer) and titanium and copper and (electroplat\$3 or plat\$3) and (board)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/04/26 08:31

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L12	12	("5994997").URPN.	USPAT	OR	ON	2006/04/26 08:26
L13	10	("4300115" "4777718" "4902610" "5162144" "5164699" "5246817" "5260170" "5347258" "5603847" "5661450").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/04/26 08:28
L17	46	((terminal or electrode) with (resist\$4)) and (circuit) and substrate and (passivation or mask or photomask or (dry adj film) or protection) and (titanium near copper) and ((electroplat\$3 or plat\$3) with (remov\$3 or etch\$3))	US-PGPUB	OR	ON	2006/04/26 08:40
L18	20	((terminal or electrode) with (resist\$4) with substrate) and (circuit) and (passivation or mask or photomask or (dry adj film) or protection) and (titanium near copper) and ((electroplat\$3 or plat\$3) with (remov\$3 or etch\$3))	US-PGPUB	OR	ON	2006/04/26 08:41